

Our test is to design and manufacture RF building block components and equipment that will enable our customers to deliver and maintain the highest quality, most cost-efficient wireless communication systems possible.

Our test components deliver precise, excellent performance even under high power conditions (average power to 100 Watts and peak power to 1000 Watts). We pay careful attention to understanding and controlling the performance characteristics that contribute to excellence in overall system performance. And we offer a variety of packaging options -- surface mount, drop-in and microstrip -- in a process that combines the best of both GaAs FET and pin diode technologies.

The products are used across a wide range of applications around the world, including CDMA, cellular, PCS, HomePNA, Bluetooth, broadband, broadcasting, radar, satellite, military, and electronic simulation.